**ON Semiconductor** 

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# Onsemí

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Preferred Device

# **VHF/UHF** Transistor

# **NPN Silicon**

# Features

• Pb–Free Package is Available

# MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	25	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	30	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	3.0	Vdc

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board $T_A = 25^{\circ}C$ Derate above 25°C	P <sub>D</sub> (Note 1)	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	556	°C/W
Total Device Dissipation Alumina Substrate, T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub> (Note 2)	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	625	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

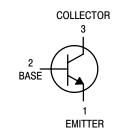
1. FR-5 = 1.0 X 0.75 X 0.062 in.

2. Alumina = 0.4 X 0.3 X 0.024 in. 99.5% alumina



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## http://onsemi.com





# MARKING DIAGRAM



14A = Specific Device Code

M = Date Code\*

=Pb–Free Package

(Note: Microdot may be in either location) \*Date Code orientation may vary depending upon manufacturing location

# ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MSD2714AT1	SC-59	3000 / Tape & Reel
MSD2714AT1G	SC–59 (Pb–Free)	3000 / Tape & Reel

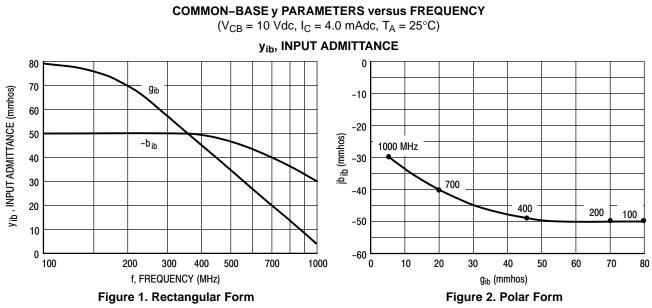
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

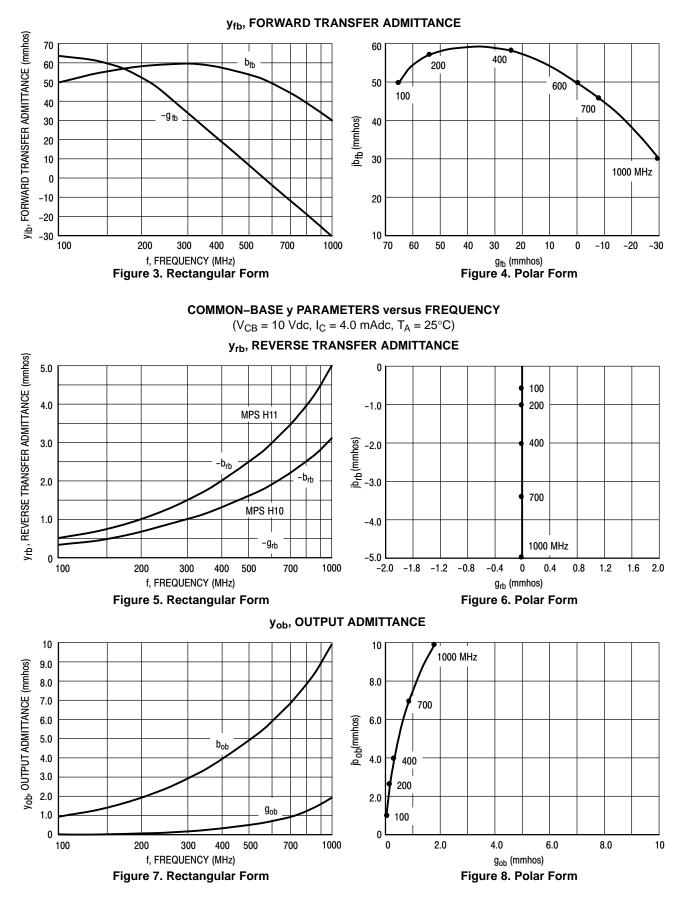
# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage $(I_C = 1.0 \text{ mAdc}, I_B = 0)$	V <sub>(BR)CEO</sub>	25	_	_	Vdc
Collector – Base Breakdown Voltage $(I_C = 10 \ \mu Adc, I_E = 0)$	V <sub>(BR)CBO</sub>	30	_	-	Vdc
Emitter – Base Breakdown Voltage $(I_E = 10 \ \mu Adc, I_C = 0)$	V <sub>(BR)EBO</sub>	3.0	_	-	Vdc
Collector Cutoff Current ( $V_{CB} = 35 \text{ Vdc}, I_E = 0$ )	I <sub>СВО</sub>	_	_	500	nAdc
Emitter Cutoff Current ( $V_{EB} = 3.5 \text{ Vdc}, I_C = 0$ )	I <sub>EBO</sub>	-	-	500	nAdc
ON CHARACTERISTICS					
DC Current Gain (I <sub>C</sub> = 1.0 mAdc, V <sub>CE</sub> = 6.0 Vdc)	h <sub>FE</sub>	90	_	180	-
Base – Emitter On Voltage (I <sub>C</sub> = 4.0 mAdc, V <sub>CE</sub> = 10 Vdc)	V <sub>BE</sub>	_	_	0.95	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current–Gain – Bandwidth Product ( $I_C = 4.0$ mAdc, $V_{CE} = 10$ Vdc, f = 100 MHz)	f <sub>T</sub>	650	-	-	MHz
Collector–Base Capacitance ( $V_{CB}$ = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>cb</sub>	-	_	0.7	pF
Common–Base Feedback Capacitance ( $V_{CB}$ = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>rb</sub>	-	-	0.65	pF
Collector Base Time Constant ( $I_C = 4.0 \text{ mAdc}, V_{CB} = 10 \text{ Vdc}, f = 31.8 \text{ MHz}$ )	rb′C <sub>c</sub>	-	-	9.0	ps

# **TYPICAL CHARACTERISTICS**

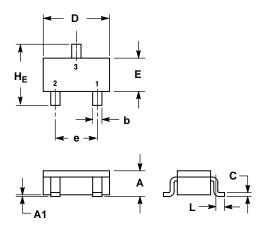


# **TYPICAL CHARACTERISTICS**



### PACKAGE DIMENSIONS

SC-59 CASE 318D-04 **ISSUE G** 



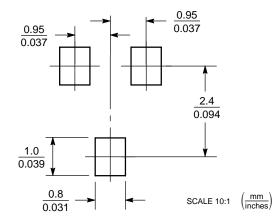
NOTES DIMENSIONING AND TOLERANCING PER ANSI 1. Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.00	1.15	1.30	0.039	0.045	0.051
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.35	0.43	0.50	0.014	0.017	0.020
С	0.09	0.14	0.18	0.003	0.005	0.007
D	2.70	2.90	3.10	0.106	0.114	0.122
Е	1.30	1.50	1.70	0.051	0.059	0.067
е	1.70	1.90	2.10	0.067	0.075	0.083
L	0.20	0.40	0.60	0.008	0.016	0.024
HE	2.50	2.80	3.00	0.099	0.110	0.118



2. BASE 3. COLLECTOR

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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